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In the United States Patent and Trademark Office

In re: Kub et al

Serial No.: 10/022,364 (NC 79,684)

Filed: December 20, 2001

For: Method For Transferring Thin Film Layer Material
To a Flexible Substrate Using a Hydrogen Splitting
Technique

Examiner: George Fourson
Art Unit: 2823

OFFICIAL

March 2, 2004

Amendment After Final Rejection

Honorable Commissioner of Patents and Trademarks
Washington, D.C. 20230

Sir:

In response to the final rejection dated Oct. 3, 2003, please amend the above-identified
as follows:

Amendments to the Specification begin on p. 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on p. 5 of this
paper.

Remarks/Arguments begin on p. 11 of this paper.